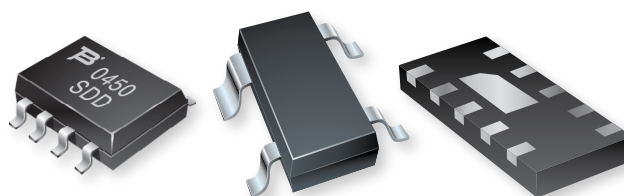




PRODUCT CHANGE NOTIFICATION

DIODES



Bourns® ESD Diode Arrays

Additional Lead Frame Material Supplier and Wafer Source Supplier

Riverside, California — June 25, 2025 — To accommodate increasing production demand and ensure continuity, effective November 1, 2025, Bourns will begin using an additional lead frame material supplier and wafer source for select Bourns® Electrostatic Discharge (ESD) Diode Arrays. A list of affected part numbers is included below. A list of affected part numbers is included below.

Affected Part Numbers	Additional Wafer Source	Additional Lead Frame Supplier
CD143A-SR2.8	v X	NA
CD143A-SR3.3	X	NA
CD143A-SR3.3C	X	NA
CD143A-SR05LC	X	NA
CDNBS08-SLVU2.8-4	X	NA
CDNBS08-SLVU2.8-4C	X	NA
CDDFN10-3324P-13	NA	X
CDDFN10-3324P	NA	X
CDDFN10-0524P	NA	X

Bourns has completed its evaluation of the alternative materials from the suppliers.

The form, fit, function, quality, reliability and data sheet specifications of the affected products remain the same. Traceability will be maintained through lot code and date code.

Samples built with the above changes are available upon request. Bourns recommends that customers test the affected part numbers in their specific applications for verification of satisfactory performance.

Implementation dates are as follows:

Date that deliveries of products manufactured using additional material suppliers will begin: **November 1, 2025**

First date code using the above changes: **2544**

Orders for the affected part numbers received after November 1, 2025 may be filled interchangeably from either the existing supplier or the additional supplier.

If you have any questions or need additional information, please feel free to [contact Customer Service/Inside Sales](#).

Users should verify that the described changes will not impact the performance of the product in their specific applications.

ESD2517